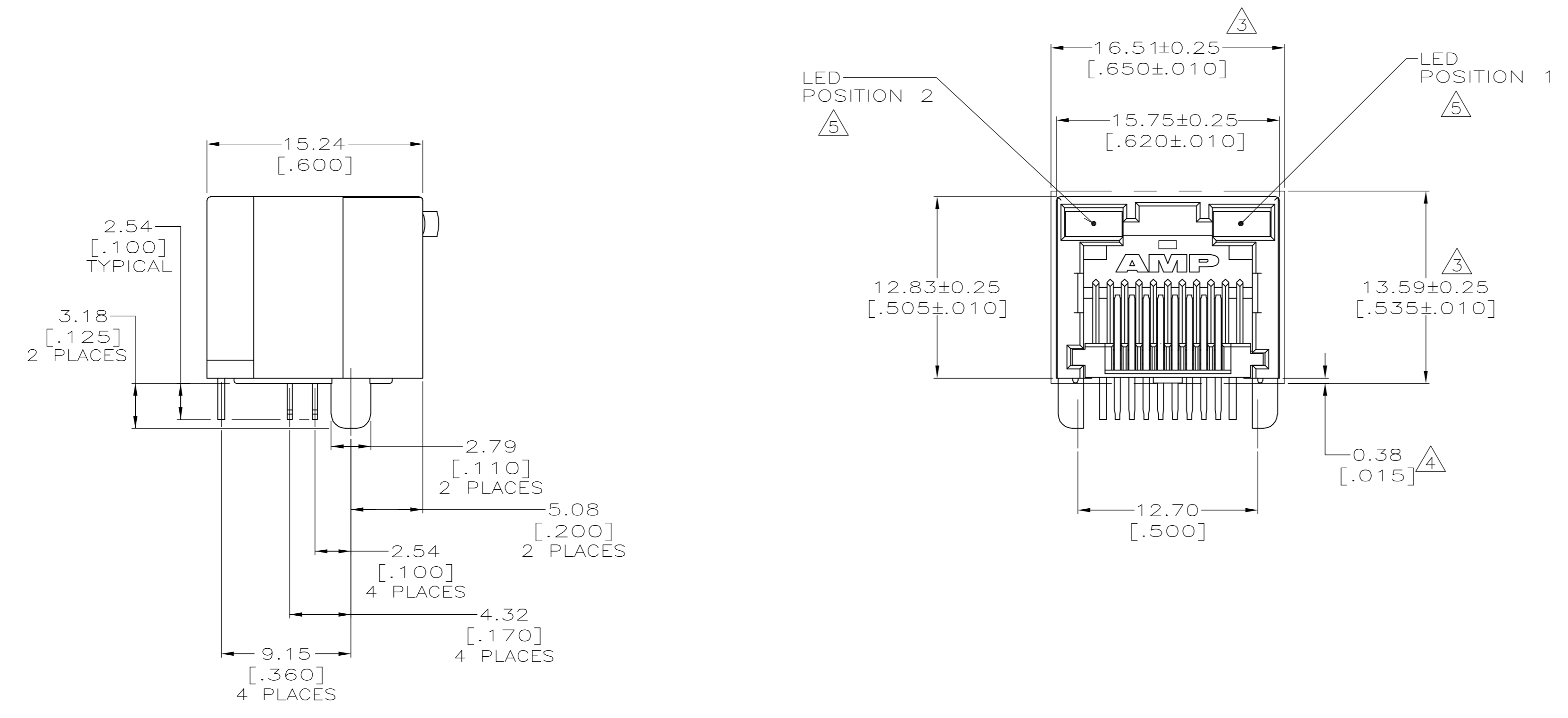
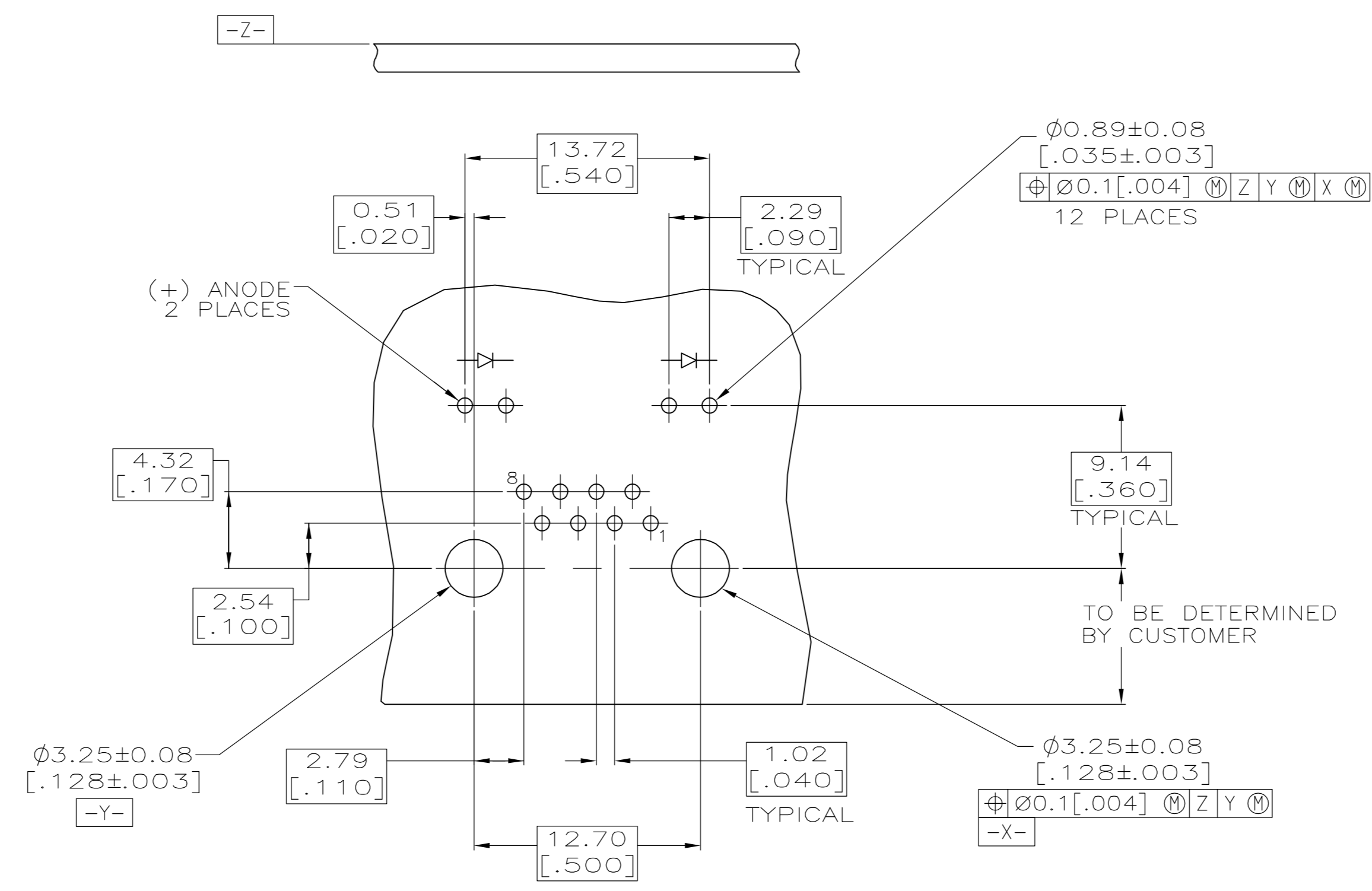


LOC		DIST		REVISIONS			
P	LR	DATE	BY	APP'D	REV	DATE	BY
A	REV PER EC	0511-0201-04	15JUN2005	LV	SF		



- △ MATERIAL:
 HOUSING - HIGH TEMPERATURE THERMOPLASTIC, BLACK, UL94V-0.
 TERMINALS - .36[.014] THICK PHOS BRONZE PLATED WITH 3.81µm[.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA. 1.27µm[.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27µm[.000050] MINIMUM THICK NICKEL.
 LIGHT EMITTING DIODE (LED) - DIFFUSED EPOXY LENS, .51 x .51[.020 x .020] CARBON STEEL WIREFRAME LEADS PREPLATED WITH 8.89µm[.0003500] THICK Sn/Cu OVER 2.03µm[.000080] THICK Ag OVER 1.02µm[.000040] THICK Cu OVER 3.56µm[.000140] THICK Ni OVER 1.02µm[.000040] Cu UNDERPLATE.
2. JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
- △ SUGGESTED PANEL OPENING DIMENSIONS.
- △ SUGGESTED CLEARANCE BETWEEN BOTTOM OF CONNECTOR AND BOTTOM PANEL OPENING.
- △ SEE TABLE FOR COLOR OF LEDS AND NUMBER REQUIRED.
6. THIS MODULAR JACK WITH INTEGRATED LED IS IR REFLOW SOLDERING PROCESS COMPATIBLE. (230°C MAX., FOR 10 SEC MAX. DURATION).



SUGGESTED PRINTED CIRCUIT BOARD LAYOUT
 (COMPONENT SIDE)

POSITION 2	POSITION 1	PART NUMBER
GREEN	GREEN	6364139-5
INDICATOR COLOR		

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS: mm [INCHES]	TOLERANCES UNLESS OTHERWISE SPECIFIED:	0 PL ± -	1 PL ± -	2 PL ± 0.25[.01]	3 PL ± 0.13[.005]	4 PL ± -	ANGLES ± -
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OWN: L. VARELA - DOCKS	15JUN2005	Tyco Electronics Corporation Harrisburg, Pa 17105-3608		
CHK: J. WESTMAN	15JUN2005			
APP'D: S. FLICKINGER	15JUN2005			
NAME: INVERTED MODULAR JACK ASSEMBLY, 1X1, LED, ZERO INSERTION FORCE				
PRODUCT SPEC: 108-1163-4	SIZE: A1	CAGE CODE: 00779	DRAWING NO: 6364139	RESTRICTED TO: -
APPLICATION SPEC: 114-2154	WEIGHT: -	SCALE: 4:1	SHEET: 1 OF 1	REV: A
MATERIAL: △	FINISH: △	CUSTOMER DRAWING		